# **Specifications for Approval**

Customer Part No.:

	Inhere Part No.:	LYG936A3-001					
	Part Name: 球头小蝴蝶水清透明黄绿光 LED						
	Spec Issue Date	: 2018-08-13					
	Revision No.: A						
========	:========		:======================================				
To Customer:	:						
We submit he ■Sample		g information for your approval: spection Record ■LE	ED Dimension				
	al Characteristics Cur ng recommendation		iagram				
Prepared by Date: 2018-	•	Checked by: Tom Date: 2018-08-13	Approved by: Wangxiaojun Date: 2018-08-13				
 Customer O	:======= )pinion		:======================================				
☐ Approve a	and no objection th the following reas	son:					



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# **SPECIFICATIONS**

#### **Features**

- High speed response.
- High reliability and long life.
- Low power consumption.
- Available in red, orange, yellow, yellow-green, green, blue, white, pink\*
- Suitable for pulse operation.
- RoHS compliant.

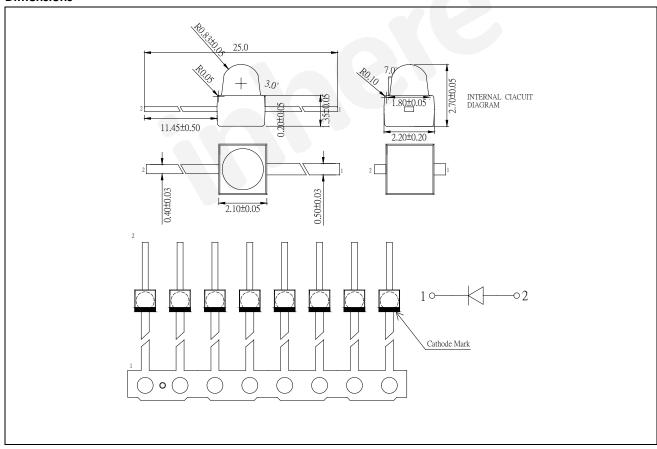
# Description

The Yellow Green source color devices are made with AlGaInP on GaAs Light Emitting Diode.

# **Applications**

- Automotive: Dashboards, stop lamps,
- Backlighting: LCDs, Key pads advertising
- Status indicators: Consumer & industrial electronics.
- General use

#### **Dimensions**



#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25 (0.01") unless otherwise noted.
- 3. Lead spacing is measured where the leads emerge from the package.
- 4. Specifications are subject to change without notice.

Part No.: LYG936A3-001 Prepared by: Lily Rev.: A Checked by: Tom

# **Selection Guide**

Part No.	Dice	Emitting Color	Lens Type	I <sub>V</sub> (mcd) @ 20mA			Viewing Angle(°)	
				Min.	Тур.	Max.	$2\theta_{\frac{1}{2}}$	
LYG936A3-001	AlGaInP	Yellow Green	Water Clear	40	100		35	

#### Note:

- $1.\, heta_{\frac{1}{2}}$  is the angle from optical centerline where the luminous intensity is  $\,\frac{1}{2}\,$  the optical centerline value.
- 2. The tolerance of luminous intensity (Iv ) is  $\pm 15\%$ .

Electrical / Optical Characteristics (at  $T_a = 25^{\circ}C$ )

Parameter	Symbol	Value					
		Min.	Тур.	Max.	Unit	Test Condition	
Forward Voltage	$V_{\rm F}$	1.8		2.4	V	I <sub>F</sub> = 20mA	
Dominant Wavelength	$\lambda_{_{\mathrm{D}}}$	565		575	nm	I <sub>F</sub> = 20mA	
Reverse Current	$I_R$			10	μА	$V_R = 5V$	
Spectral Line Half Width	Δλ		18	~7 P	nm	I <sub>F</sub> = 20mA	

#### Note:

- 1.The tolerance of forward voltage is  $\pm\,$  0.05V..
- 2. The tolerance of dominant wavelength is ±1nm.
- 3. This specification is a standard specification of our factory, can make in accordance with customer's special requirement.

Absolute Maximum Ratings (at  $T_a = 25$ °C)

Parameter	Symbol	Value	Unit	
Power Dissipation	$P_{D}$	95	mW	
Peak Forward Current *1	$I_{\mathrm{FP}}$	100	mA	
Forward Current	$I_{\mathrm{F}}$	25	mA DC	
Reverse Voltage	$V_R$	5	V DC	
Operating Temperature	$T_{ m opr}$	-40 ~ +85	°C	
Storage Temperature	$T_{ m stg}$	-40 ~ +100	°C	
Soldering Temperature	$T_{\rm sol}$	260°C for 5 sec 3 times		

 $<sup>\,</sup>$   $\!\!$   $\!\!$   $\!\!$   $\!\!$  1 Condition for IFP is pulse of 1/10 duty and 0.1msec width.

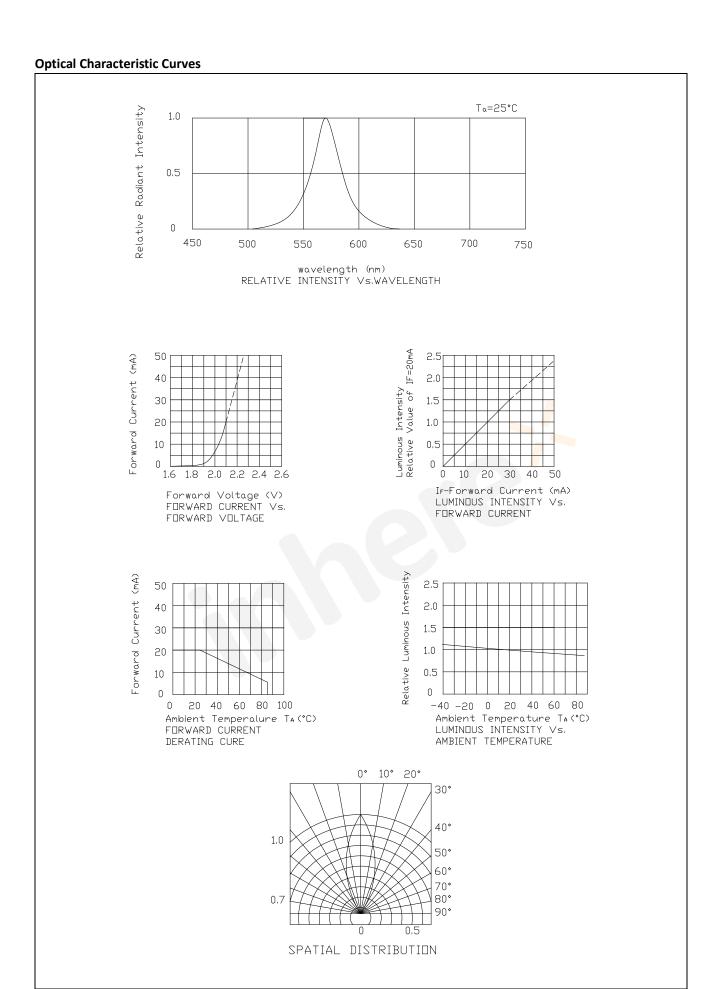
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**Reliability Testing Conditions** 

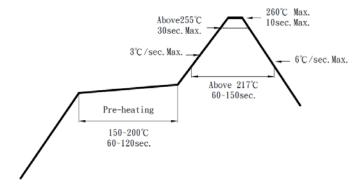
Classification	Test Item	Reference Standard	Test Conditions	Result
Endurance Test	Operation Life	MIL-STD-750D:1026 MIL-STD-883D:1005 JIS-C-7021:B-1	Ta: Under room temperature  Test time:1,000hrs  IF= Product Recommended IF	0/32
	High Temperature High Humidity Storage	MIL-STD-202F:103B JIS-C-7021:B-11	Ta:85±5°C RH:90%-95% Test time:240hrs	0/32
	High Temperature Storage  MIL-STD-883:1008  Ta:100±5℃  Test time:1,000hrs			0/32
	Low Temperature Storage	JIS-C-7021:B-11	Ta:-40±5℃ Test time:1,000hrs	0/32
Environmental Test	Temperature Cycling	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1010 JIS-C-7021:A-2	Ta: -40 $^{\circ}$ C $\pm$ 5 $^{\circ}$ C $\sim$ 25 $^{\circ}$ C $\pm$ 5 $^{\circ}$ C $\sim$ 100 $^{\circ}$ C $\pm$ 5 $^{\circ}$ C $\sim$ 25 $^{\circ}$ C $\pm$ 5 $^{\circ}$ C $\rightarrow$ 30min 5min 30min 5min	0/32
	Thermal Chock	MIL-STD-202F:107D(1980) MIL-STD-750D:1051(95) MIL-STD-883D:1011(1991)	Ta: $-40$ $^{\circ}$ $\pm$ 5 $^{\circ}$ $^{\circ}$ $^{\circ}$ $^{\circ}$ $^{\circ}$ $^{\circ}$ $^{\circ}$ $^{\circ}$ $^{\circ}$ 10min 10min Time:20min/cycle 10cycle	0/32
	Wetting balance	MIL-STD-883:2003 MIL-STD-202F:208D MIL-STD-883D:2003	Ta: 230℃±5℃ Time:5±0.5s	0/32
	Solder Resistance	MIL-STD-202F:210A MIL-STD-883D:1011 JIS-C-7021:A-1	Ta: 260 °C ± 10 °C Time:10 ± 1s	0/32

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# **IR-Reflow Soldering**



- 1. Avoid any external stress applied to the resin while the LEDs are at high temperature, especially during soldering.
- 2. Avoid rapid cooling or any excess vibration during temperature ramp-down process
- 3. Although the soldering condition is recommended above, soldering at the lowest possible temperature is feasible for the LEDs

### **IRON Soldering**

350℃ Within 3 sec., One time only.

#### Notes for designing:

Care must be taken to provide the current limiting resistor in the circuit so as to drive the Inhere LEDs within the rated figures. Also, caution should be taken not to overload Inhere LEDs with instantaneous voltage at the turning ON and OFF of the circuit.

When using the pulse drive care must be taken to keep the average current within the rated figures. Also, the circuit should be

designed so as be subjected to reverse voltage when turning off the Inhere LEDs.

# Storage:

In order to avoid the absorption of moisture, it is recommended to solder Inhere LEDs as soon as possible after unpacking the sealed envelope.

If the envelope is still packed, to store it in the environment as following:

- (1) Temperature: 5°C-30°C; Humidity: RH 60%Max.
- (2) After this bag is opened, devices that will be applied to infrared refold, vapor-phase refold, or equivalent soldering process must be:
- a. Completed within 168 hours.
- b. Stored at less than 30% RH.
- (3) Devices require baking before mounting, if:
- (2) a or (2) b is not met.
- (4) If baking is required, devices must be baked under below conditions:
- 48 hours at 60°C±3°C.

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